Docket No.: JCLA24053

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Name of conveying party(ies) with the execution date:	2. Name/address of receiving Party(ies)	
SHENG-YUAN LEE, September 17, 2007	VIA TECHNOLOGIES, INC.	
HSIAO-CHU LIN, September 17, 2007	8F, NO. 533, CHUNG-CHENG RD., HSIN-TIEN CITY, TAIPEI HSIEN, TAIWAN, R.O.C.	
3. Nature of conveyance: Assignment Security Agreement Merger Change of Name Reassignment X Other		
Record to correct the second inventor's name on an Assignment previously recorded on real 019877 and frame 0807.	Add'1 names of receiving parties Attached? Yes X No	
4. Application number(s) or patent number(s):		
A. Patent Application No. (s)	B. Patent No.(s)	
11/860,766		
Additional number attached?		
Name and address of party to whom correspondence concerning document should be mailed:	6. Total No. of applications and patents involved: ONE (1)	
J. C. Patents	7. Total fee(37CFR§3.41): \$ 40.00 Authorized to be charged by credit card	
4 Venture, Suite 250 Irvine, CA 92618	X Authorized to be charge to deposit account Enclosed	
(949) 660-0761	None required (government interest not affecting title) 8. Payment Information a. Credit Card Last 4 Numbers Expiration Date b. Deposit Account Number 50-0710	
Atty Docket No.: JCLA24053 9. Statement and Signature:	Authorized User Name <u>Jiawei Huang</u>	
· ·	lief, the forging information is true and true copy of the original document.	
Jiawei Huang Name of person Signing Registration No. 43,330	Total number of pages including cover sheet, attachments, and documents: 3	

PATENT REEL: 022431 FRAME: 0793 USPTO

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Statement and Signature: To the best of my knowledge and be Correct and any attached copy is a telegraph.	elief, the forging information is true and true copy of the original document.
Jlawei Huang	9-25-2007 Total number of pages including cover sheet,
ame of person Signing Signature gegistration No. 43,330	Date / attachments, and documents: 3

PATENT

REEL: 022431 FRAME: 0794

VIT07-0038 24053-US-PA

ASSIGNMENT

WHEREAS,

1. Lee, Sheng-Yuan

2. Lin, Hsiao-Chu

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: INDUCTOR STRUCTURE

[] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, VIA Technologies, Inc.

of 8F, No. 535, Chung-Cheng Rd., Hsin-Tien City, Taipei Hsien, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

VIT07-0038 24053-US-PA

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Sungform he Date: 2007-09-17

Sole or First Joint Inventor: Lee, Sheng-Yuan

Signature: Hsiao - Chu Uin

Date: 2007-09-17

Second Joint Inventor (if any): Lin, Hsiao-Chu